Panasonic



Not Recommended for New Design: RE Series Relays

NRFND.PGA0001.12.26.2018 12.26.2018

About This Notice:	The RE Series Relays have changed status to Not Recommended For New Design due to possible plans for discontinuation in the future.
Features:	
Effective Date:	Immediate
Affected Parts and/or Replacements:	See attached. The closest substitute would be the RS Series Relay which is not a drop-in replacement.
Datasheet(s):	See attached.
Notes:	

Panasonic NRFND.PGA0001.12.26.2018 RE Series Relays

Affected Parts

ARE1003

ARE1006

ARE1009

ARE1012

ARE1024

ARE104H

ARE10A03

ARE10A06

ARE10A09

ARE10A12

ARE10A12Z

ARE10A24

ARE10A4H

ARE10A4HZ

ARE1303

ARE1306

ARE1309

ARE1312

ARE1324

ARE134H

ARE13A03

ARE13A03Z

ARE13A12

ARE13A12Z

ARE13A24

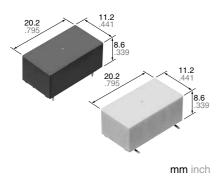
ARE13A4H

ARE13A4HZ

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2.6 GHz capable, 10 W carrying power (at 2.6 GHz), $50\Omega/75\Omega$ impedance and 1 Form C relays

RE RELAYS (ARE)



FEATURES

- Excellent high frequency characteristics (to 2.6GHz)
- Surface-mount type also available
- Compact and slim size Size: 20.2(L) \times 11.2(W) \times 8.9(H)* mm .795(L) \times .441(W) \times .350(H) inch
- *The height of Surface-mount type is 9.6 mm .378 inch size.

TYPICAL APPLICATIONS

- 1. Broadcasting and video markets.
 - Digital broadcasting equipment
 - STB/tuner

2. Communications market

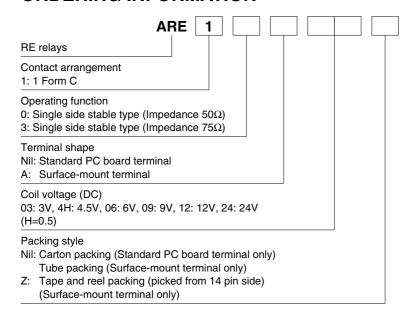
- Antennae switching
- · All types of wireless devices

If you consider using applications with low level loads or with high frequency switching, please consult us.

RoHS compliant

Protective construction: Sealed type

ORDERING INFORMATION



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TYPES

1. Standard PC board terminal

Rated voltage	Part No.			Standard packing	
	Single side stable type (Impedance 50Ω)	Single side stable type (Impedance 75 Ω)	Carton	Case	
3 V DC	ARE1003 ARE1303				
4.5 V DC	ARE104H	ARE134H			
6 V DC	ARE1006	ARE1306	F0 noo	500 pcs.	
9 V DC	ARE1009	ARE1309	50 pcs.	500 pcs.	
12 V DC	ARE1012 ARE1312				
24 V DC	ARE1024	ARE1324			

2. Surface-mount terminal

1) Tube package

Dated voltage	Part No.			Standard packing	
Rated voltage	Single side stable type (Impedance 50Ω) Single side stable type (Impedance 75Ω)		Tube	Case	
3 V DC	ARE10A03 ARE13A03				
4.5 V DC ARE10A4H		ARE13A4H			
6 V DC	ARE10A06	ARE13A06	0F non	000 200	
9 V DC	ARE10A09	ARE13A09	25 pcs.	200 pcs.	
12 V DC	ARE10A12	ARE13A12			
24 V DC	ARE10A24	ARE13A24			

2) Tape and reel package

Dated valtage	Part	Standard packing		
Rated voltage	Single side stable type (Impedance 50Ω) Single side stable type (Impedance 75Ω)		Tape and reel	Case
3 V DC	ARE10A03Z ARE13A03Z			
4.5 V DC	ARE10A4HZ	ARE13A4HZ		
6 V DC	ARE10A06Z	ARE13A06Z	400 pcs.	900 200
9 V DC	ARE10A09Z	ARE13A09Z	400 pcs.	800 pcs.
12 V DC	ARE10A12Z	ARE13A12Z		
24 V DC	ARE10A24Z	ARE13A24Z		

RATING

1. Coil data

Rated voltage	Pick-up voltage* (at 20°C 68°F)	Drop-out voltage* (at 20°C 68°F)	Rated operating current [±10%] (at 20°C 68°F)	Coil resistance [±10%] (at 20°C 68°F)	Rated operating power	Max. allowable voltage
3 V DC		66.7 mA	45 Ω			
4.5 V DC		44.4 mA	101 Ω			
6 V DC	75%V or less of rated voltage	e rated voltage	33.3 mA	180 Ω	200 mW	110%V (at 60°C 140°F)
9 V DC	(Initial)		22.2 mA	405 Ω	200 11100	150%V (at 20°C 68°F) of rated voltage
12 V DC		16.7 mA	720 Ω		or ration rollage	
24 V DC				2,880 Ω		

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ASCTB104E 201703-T

^{*} Square, pulse drive (JIS C5442)

2. Specifications

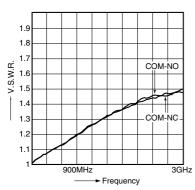
Characteristics		Item	Specifications	
	Arrangement		1 Form C	
	Contact resistance (initial)		Max. 100mΩ (By voltage drop 10V AC 10mA)	
	Contact mat	erial	Gold plating	
Contact data	Contact ratio	ng (resistive)	1W (at 2.6 GHz [Impedance 50Ω, V.S.W.R. Max.1.7] [Impedance 75Ω;, V.S.W.R. Max.1.5]) 10mA 24V DC	
	Contact inpu	ut power	10W (at 2.6GHz [Impedance 50Ω, V.S.W.R. Max.1.7] [Impedance 75Ω, V.S.W.R. Max.1.5])	
	Max. switchi	ng voltage	30V DC	
	Max. switchi	ng current	0.5A DC	
High frequency	V.S.W.R.		Max. 1.3 (to 900MHz), Max. 1.7 (to 2.6GHz)	
characteristics (Initial)	Insertion los	s	Max. 0.2dB (to 900MHz), Max. 0.7dB (to 2.6GHz)	
(Impedance 50Ω)	Isolation		Min. 60dB (to 900MHz), Min. 30dB (to 2.6GHz)	
High frequency	V.S.W.R.		Max. 1.2 (to 900MHz), Max. 1.5 (to 2.6GHz)	
characteristics (Initial)	Insertion los	s	Max. 0.2dB (to 900MHz), Max. 0.5dB (to 2.6GHz)	
(Impedance 75Ω)	Isolation		Min. 60dB (to 900MHz), Min. 30dB (to 2.6GHz)	
Insulation resistance (I	n resistance (Initial)		Min. $100M\Omega$ (at 500V DC, Measured portion is the same as the case of dielectric voltage.)	
D 11	Between open contacts		500 Vrms for 1min. (detection current: 10mA)	
Breakdown voltage (Initial)	Between contact and coil		1,000 Vrms for 1min. (detection current: 10mA)	
(midal)	Between contact and earth terminal		500 Vrms for 1min. (detection current: 10mA)	
Time characteristics	Operate time (initial)		Max. 10ms (at 20°C 68°F, at rated voltage, without bounce)	
Time characteristics	Release time (initial)		Max. 5ms (at 20°C 68°F, at rated voltage, without bounce, without diode)	
	Shock	Functional	Min. 500 m/s² (half-sine shock pulse: 11ms; detection time: 10μs)	
Mechanical	resistance	Destructive	Min. 1,000m/s ² (half-sine shock pulse: 6ms)	
characteristics	Vibration	Functional	10 to 55 Hz at double amplitude of 3mm (detection time: 10μs)	
	resistance	Destructive	10 to 55 Hz at double amplitude of 5mm	
	Mechanical		Min. 10 ⁶ (at 180 times/min.)	
Expected life	Electrical		Min. 3×10^{5} (1W, 2.6GHz, [Impedance 50Ω, V.S.W.R. \leq 1.7] [Impedance 75Ω, V.S.W.R. \leq 1.5]] Min. 3×10^{5} (10mA 24V DC (resistive) (at 20 times/min.))	
Conditions	Conditions for operation, transport and storage*		Ambient temperature: -40 to +70°C -40 to +158°F Humidity: 5 to 85% R.H. (Not freezing and condensing at low temperature)	
Unit weight			Approx. 5 g .18 oz	

Note: * The upper operation ambient temperature limit is the maximum temperature that can satisfy the coil temperature rise value. Refer to [6] AMBIENT ENVIRONMENT in GENERAL APPLICATION GUIDELINES.

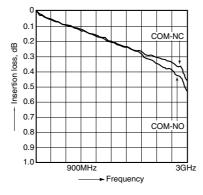
REFERENCE DATA

1-(1). High frequency characteristics (Impedance 50Ω) (Standard PC board terminal)

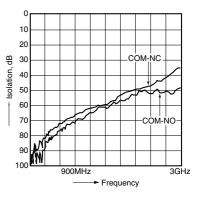
• V.S.W.R. characteristics



• Insertion loss characteristics

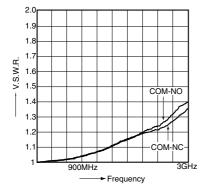


• Isolation characteristics

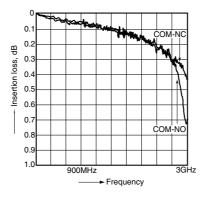


1-(2). High frequency characteristics (Impedance 75Ω) (Standard PC board terminal)

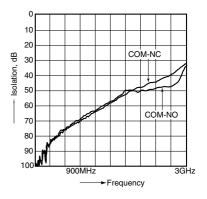




• Insertion loss characteristics



• Isolation characteristics



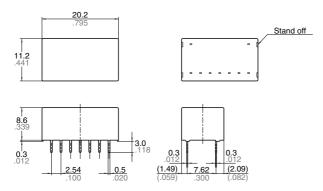
DIMENSIONS (mm inch)

The CAD data of the products with a CAD mark can be downloaded from: http://industrial.panasonic.com/ac/e/

1. Standard PC board terminal (50 Ω , 75 Ω type)

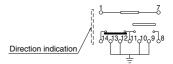






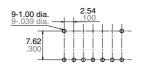
Tolerance: $\pm 0.3 \pm .012$

Schematic (Bottom view)



(Deenergized condition)

PC board pattern



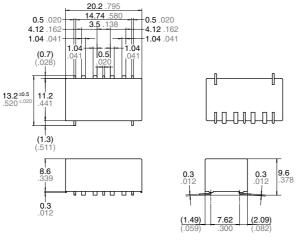
Tolerance: ±0.1 ±.004

2. Surface mount terminal

• 50 Ω type

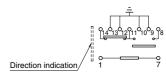
CAD





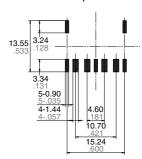
Tolerance: $\pm 0.3 \pm .012$

Schematic (Top view)



(Deenergized condition)

PC board pattern

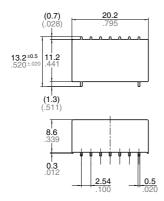


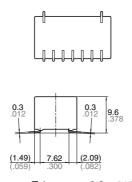
Tolerance: ±0.1 ±.004

• 75 Ω type



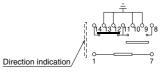






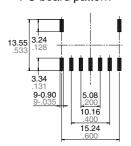
Tolerance: $\pm 0.3 \pm .012$

Schematic (Top view)



(Deenergized condition)

PC board pattern



Tolerance: $\pm 0.1 \pm .004$

NOTES

1. Coil operating power

Pure DC current should be applied to the coil. The wave form should be rectangular. If it includes ripple, the ripple factor should be less than 5%.

However, check it with the actual circuit since the characteristics may be slightly different.

2. Cleaning

For automatic cleaning, the boiling method is recommended. Avoid ultrasonic cleaning which subjects the relays to high frequency vibrations, which may cause the contacts to stick. It is recommended that alcoholic solvents be used.

3. Soldering

(Standard PC board terminal)

1) The manual soldering shall be performed under following condition.

Max. 260°C 500°F 10s Max. 350°C 662°F 3s

The affect of the PCB on the relay will differ depending on the type of PCB used. Please verify the type of PCB to be used. Preheat according to the following conditions.

Temperature	120°C 248°F or less
Time	Within 2 minute

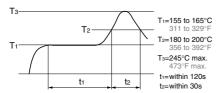
Soldering should be done at 260±5°C 500±9°F within 6 s. 2) In case of automatic soldering, the following conditions should be observed (Surface-mount terminal)

(1) Position of measuring temperature



A: Surface of PC board where relay is mounted

(2) IR (infrared reflow) soldering method

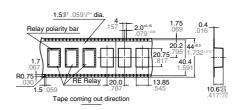


Temperature rise of relay itself may vary according to the mounting level or the heating method of reflow equipment. Therefore, please set the temperature of soldering portion of relay terminal and the top surface of the relay case not to exceed the above mentioned soldering condition.

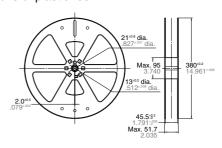
It is recommended to check the temperature rise of each portion under actual mounting condition before use.

4. Packing style

1) Tape dimensions



2) Dimensions of plastic reel



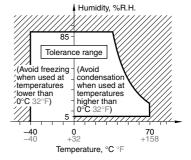
5. Conditions for operation, transport and storage conditions

- 1) Ambient temperature, humidity, and atmospheric pressure during usage, transport, and storage of the relay:
- (1) Temperature:
- -40 to +70°C -40 to +158°F
- (2) Humidity: 5 to 85% RH

(Avoid freezing and condensation.)

The humidity range varies with the temperature. Use within the range indicated in the graph below.

(3) Atmospheric pressure: 86 to 106 kPa Temperature and humidity range for usage, transport, and storage:



2) Condensation

Condensation forms when there is a sudden change in temperature under high temperature and high humidity conditions. Condensation will cause deterioration of the relay insulation.

3) Freezing

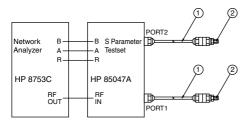
Condensation or other moisture may freeze on the relay when the temperature is lower than 0°C 32°F. This causes problems such as sticking of movable parts or operational time lags.

4) Low temperature, low humidity environments

The plastic becomes brittle if the relay is exposed to a low temperature, low humidity environment for long periods of time.

6. Measuring method

1) 50Ω type

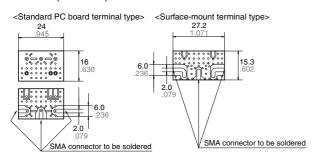


Connect connectors 1 and 2 respectively to PORT1 and PORT2. Perform calibration using the 3.5 mm .138 inch calibration kit (50 Ω).

No.	Part number	Description
1	HP 11857D	7mm .276inch Test port, Extension cable. (APC7 connector)
2	HP 11533A	Adapter APC7-SMA (Male)

After calibration, connect the D.U.T board and measure.

D.U.T board Dimension (mm inch)



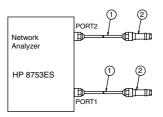
Material: Glass PTFE (Double sided, Through hole) R-4737 (Panasonic Corporation)

Thickness: t = 0.8 mm .031inch Copper thickness: $18\mu m$

Connector (SMA)

Product name: R125 510 (RADIALL)

2) 75Ω type

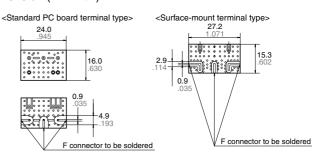


Connect connectors 1 and 2 respectively to PORT1 and PORT2. Perform calibration using the 3.5 mm .138 inch calibration kit (70Ω) .

No.	Part number	Description
1	HP 11857B	75ΩF Test port, Return cable
2	85039-60011	Adapter 75ΩN (Female) – 75ΩF (Male)

After calibration, connect the D.U.T board and measure.

D.U.T board Dimension (mm inch)



Material: Glass PTFE (Double sided, Through hole) R-4737 (Panasonic Corporation)

Thickness: t = 0.8 mm .031inch Copper thickness: $18 \mu m$

Connector (F)

Product name: C05-0236 (KOMINE MUSEN DENKI)

For general cautions for use, please refer to the "General Application Guidelines".

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Specifications are subject to change without notice.